

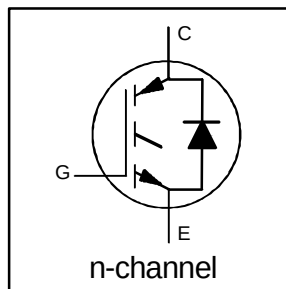
**INSULATED GATE BIPOLAR TRANSISTOR  
WITH ULTRAFAST SOFT RECOVERY**

**Fast CoPack IGBT**

**DIODE**

**Features**

- Switching-loss rating includes all "tail" losses
- HEXFRED™ soft ultrafast diodes
- Optimized for medium operating frequency (1 to 10kHz) See Fig. 1 for Current vs. Frequency curve



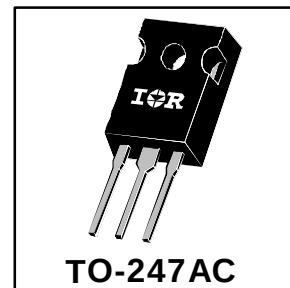
$$V_{CES} = 1200V$$

$$V_{CE(sat)} \leq 2.9V$$

$$@V_{GE} = 15V, I_C = 25A$$

**Description**

Co-packaged IGBTs are a natural extension of International Rectifier's well known IGBT line. They provide the convenience of an IGBT and an ultrafast recovery diode in one package, resulting in substantial benefits to a host of high-voltage, high-current, motor control, UPS and power supply applications.



**Absolute Maximum Ratings**

|                           | Parameter                          | Max.                | Units      |
|---------------------------|------------------------------------|---------------------|------------|
| $V_{CES}$                 | Collector-to-Emitter Voltage       | 1200                | V          |
| $I_C @ T_C = 25^\circ C$  | Continuous Collector Current       | 45                  | A          |
| $I_C @ T_C = 100^\circ C$ | Continuous Collector Current       | 25                  |            |
| $I_{CM}$                  | Pulsed Collector Current ①         | 90                  |            |
| $I_{LM}$                  | Clamped Inductive Load Current ②   | 90                  |            |
| $I_F @ T_C = 100^\circ C$ | Diode Continuous Forward Current   | 16                  |            |
| $I_{FM}$                  | Diode Maximum Forward Current      | 90                  | V          |
| $V_{GE}$                  | Gate-to-Emitter Voltage            | $\pm 20$            |            |
| $P_D @ T_C = 25^\circ C$  | Maximum Power Dissipation          | 200                 | W          |
| $P_D @ T_C = 100^\circ C$ | Maximum Power Dissipation          | 78                  |            |
| $T_J$                     | Operating Junction and             | -55 to +150         | $^\circ C$ |
| $T_{STG}$                 | Storage Temperature Range          |                     |            |
|                           | Soldering Temperature, for 10 sec. |                     |            |
|                           | Mounting Torque, 6-32 or M3 Screw. | 10 lbf•in (1.1 N•m) |            |

**Thermal Resistance**

|                 | Parameter                                 | Min. | Typ.     | Max. | Units        |
|-----------------|-------------------------------------------|------|----------|------|--------------|
| $R_{\theta JC}$ | Junction-to-Case - IGBT                   | —    | —        | 0.64 | $^\circ C/W$ |
| $R_{\theta JC}$ | Junction-to-Case - Diode                  | —    | —        | 0.83 |              |
| $R_{\theta CS}$ | Case-to-Sink, flat, greased surface       | —    | 0.24     | —    |              |
| $R_{\theta JA}$ | Junction-to-Ambient, typical socket mount | —    | —        | 40   |              |
| $Wt$            | Weight                                    | —    | 6 (0.21) | —    | g (oz)       |

Electrical Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)

|                                 | Parameter                                | Min. | Typ. | Max.      | Units   | Conditions                                             |
|---------------------------------|------------------------------------------|------|------|-----------|---------|--------------------------------------------------------|
| $V_{(BR)CES}$                   | Collector-to-Emitter Breakdown Voltage ③ | 1200 | —    | —         | V       | $V_{GE} = 0V, I_C = 250\mu A$                          |
| $\Delta V_{(BR)CES}/\Delta T_J$ | Temperature Coeff. of Breakdown Voltage  | —    | 1.1  | —         | V/°C    | $V_{GE} = 0V, I_C = 1.0mA$                             |
| $V_{CE(on)}$                    | Collector-to-Emitter Saturation Voltage  | —    | 2.1  | 2.9       | V       | $I_C = 25A$ $V_{GE} = 15V$                             |
|                                 |                                          | —    | 2.5  | —         |         | $I_C = 45A$ See Fig. 2, 5                              |
|                                 |                                          | —    | 3.0  | —         |         | $I_C = 25A, T_J = 150^\circ\text{C}$                   |
| $V_{GE(th)}$                    | Gate Threshold Voltage                   | 3.0  | —    | 5.5       |         | $V_{CE} = V_{GE}, I_C = 250\mu A$                      |
| $\Delta V_{GE(th)}/\Delta T_J$  | Temperature Coeff. of Threshold Voltage  | —    | -14  | —         | mV/°C   | $V_{CE} = V_{GE}, I_C = 250\mu A$                      |
| $g_{fe}$                        | Forward Transconductance ④               | 7.5  | 17   | —         | S       | $V_{CE} = 100V, I_C = 25A$                             |
| $I_{CES}$                       | Zero Gate Voltage Collector Current      | —    | —    | 250       | $\mu A$ | $V_{GE} = 0V, V_{CE} = 1200V$                          |
|                                 |                                          | —    | —    | 6500      |         | $V_{GE} = 0V, V_{CE} = 1200V, T_J = 150^\circ\text{C}$ |
| $V_{FM}$                        | Diode Forward Voltage Drop               | —    | 2.5  | 3.0       | V       | $I_C = 16A$ See Fig. 13                                |
|                                 |                                          | —    | 2.1  | 2.5       |         | $I_C = 16A, T_J = 150^\circ\text{C}$                   |
| $I_{GES}$                       | Gate-to-Emitter Leakage Current          | —    | —    | $\pm 100$ | nA      | $V_{GE} = \pm 20V$                                     |

Switching Characteristics @  $T_J = 25^\circ\text{C}$  (unless otherwise specified)

|                  | Parameter                                        | Min. | Typ. | Max. | Units      | Conditions                                               |
|------------------|--------------------------------------------------|------|------|------|------------|----------------------------------------------------------|
| $Q_g$            | Total Gate Charge (turn-on)                      | —    | 82   | 100  | nC         | $I_C = 25A$                                              |
| $Q_{ge}$         | Gate - Emitter Charge (turn-on)                  | —    | 16   | 21   |            | $V_{CC} = 400V$                                          |
| $Q_{gc}$         | Gate - Collector Charge (turn-on)                | —    | 30   | 43   |            | See Fig. 8                                               |
| $t_{d(on)}$      | Turn-On Delay Time                               | —    | 77   | —    | ns         | $T_J = 25^\circ\text{C}$                                 |
| $t_r$            | Rise Time                                        | —    | 75   | —    |            | $I_C = 25A, V_{CC} = 800V$                               |
| $t_{d(off)}$     | Turn-Off Delay Time                              | —    | 360  | 540  |            | $V_{GE} = 15V, R_G = 5.0\Omega$                          |
| $t_f$            | Fall Time                                        | —    | 320  | 470  |            | Energy losses include "tail" and diode reverse recovery. |
| $E_{on}$         | Turn-On Switching Loss                           | —    | 3.2  | —    | mJ         | See Fig. 9, 10, 11, 18                                   |
| $E_{off}$        | Turn-Off Switching Loss                          | —    | 5.8  | —    |            |                                                          |
| $E_{ts}$         | Total Switching Loss                             | —    | 9.0  | 13.5 |            |                                                          |
| $t_{d(on)}$      | Turn-On Delay Time                               | —    | 70   | —    | ns         | $T_J = 150^\circ\text{C}$ , See Fig. 9, 10, 11, 18       |
| $t_r$            | Rise Time                                        | —    | 70   | —    |            | $I_C = 25A, V_{CC} = 800V$                               |
| $t_{d(off)}$     | Turn-Off Delay Time                              | —    | 660  | —    |            | $V_{GE} = 15V, R_G = 5.0\Omega$                          |
| $t_f$            | Fall Time                                        | —    | 640  | —    |            | Energy losses include "tail" and diode reverse recovery. |
| $E_{ts}$         | Total Switching Loss                             | —    | 16.2 | —    | mJ         |                                                          |
| $L_E$            | Internal Emitter Inductance                      | —    | 13   | —    | nH         | Measured 5mm from package                                |
| $C_{ies}$        | Input Capacitance                                | —    | 2400 | —    | pF         | $V_{GE} = 0V$                                            |
| $C_{oes}$        | Output Capacitance                               | —    | 140  | —    |            | $V_{CC} = 30V$ See Fig. 7                                |
| $C_{res}$        | Reverse Transfer Capacitance                     | —    | 28   | —    |            | $f = 1.0MHz$                                             |
| $t_{rr}$         | Diode Reverse Recovery Time                      | —    | 90   | 135  | ns         | $T_J = 25^\circ\text{C}$ See Fig. 14                     |
|                  |                                                  | —    | 164  | 245  |            | $T_J = 125^\circ\text{C}$                                |
| $I_{rr}$         | Diode Peak Reverse Recovery Current              | —    | 5.8  | 10   | A          | $T_J = 25^\circ\text{C}$ See Fig. 15                     |
|                  |                                                  | —    | 8.3  | 15   |            | $T_J = 125^\circ\text{C}$                                |
| $Q_{rr}$         | Diode Reverse Recovery Charge                    | —    | 260  | 675  | nC         | $T_J = 25^\circ\text{C}$ See Fig. 16                     |
|                  |                                                  | —    | 680  | 1838 |            | $T_J = 125^\circ\text{C}$                                |
| $di_{(rec)M}/dt$ | Diode Peak Rate of Fall of Recovery During $t_b$ | —    | 120  | —    | A/ $\mu s$ | $T_J = 25^\circ\text{C}$ See Fig. 17                     |
|                  |                                                  | —    | 76   | —    |            | $T_J = 125^\circ\text{C}$                                |

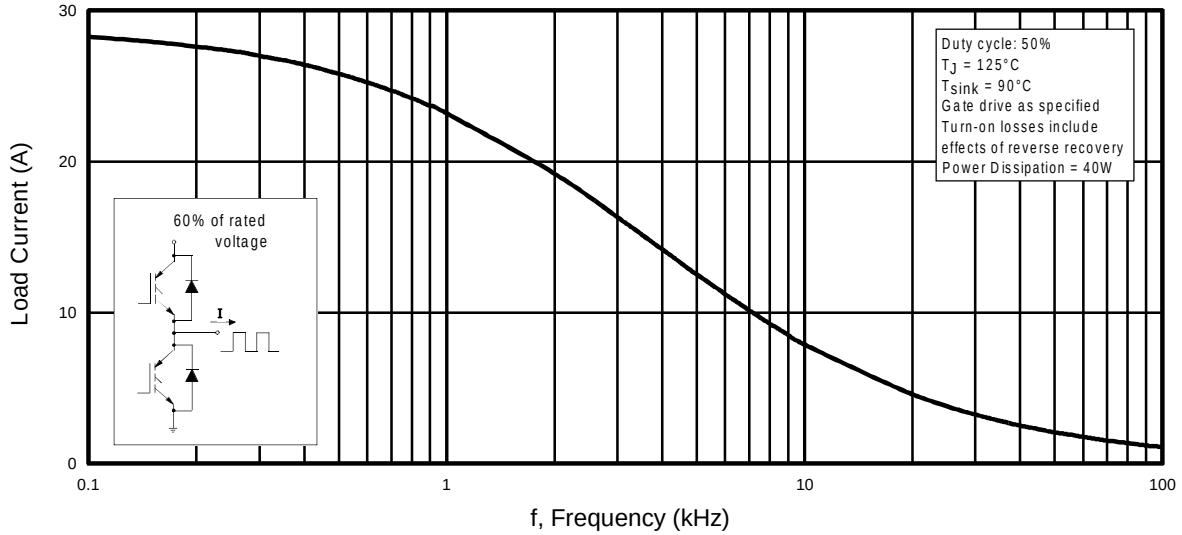
## Notes:

① Repetitive rating;  $V_{GE}=20V$ , pulse width limited by max. junction temperature. ( See fig. 20 )

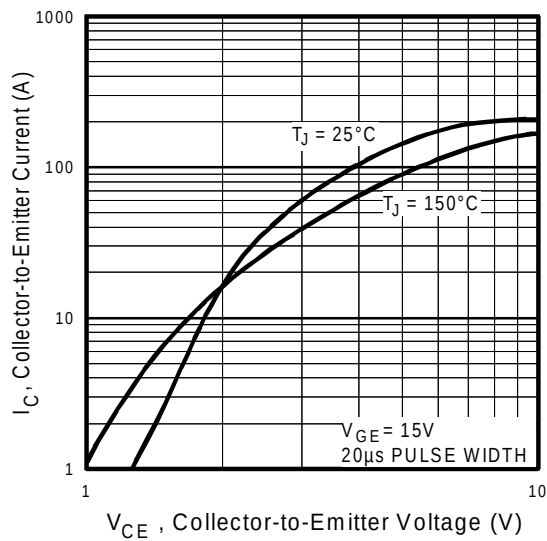
②  $V_{CC}=80\%(V_{CES})$ ,  $V_{GE}=20V$ ,  $L=10\mu H$ ,  $R_G = 5.0\Omega$ , ( See fig. 19 )

③ Pulse width  $\leq 80\mu s$ ; duty factor  $\leq 0.1\%$ .

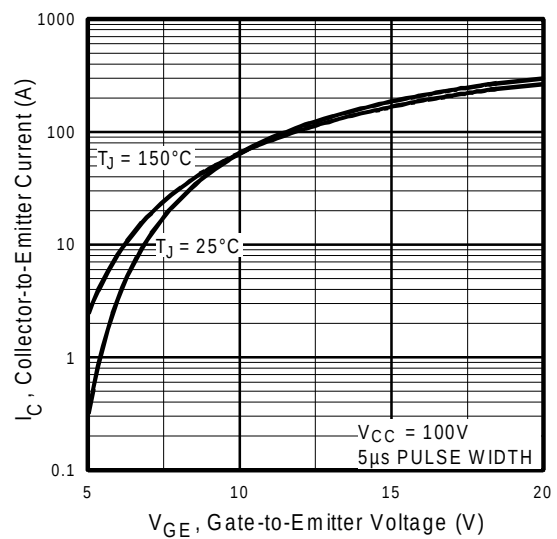
④ Pulse width  $5.0\mu s$ , single shot.



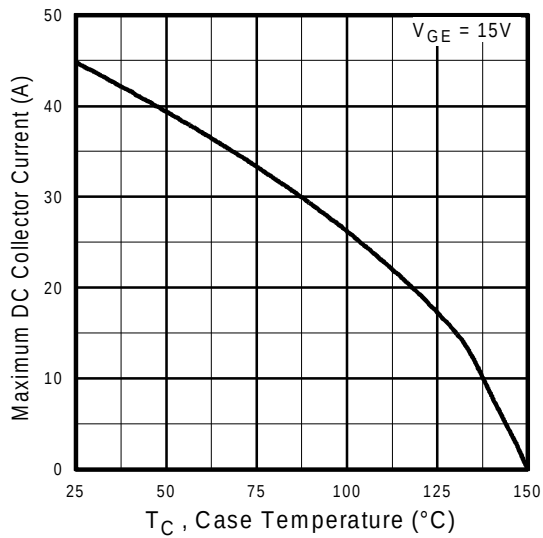
**Fig. 1 - Typical Load Current vs. Frequency**  
 (Load Current =  $I_{\text{RMS}}$  of fundamental)



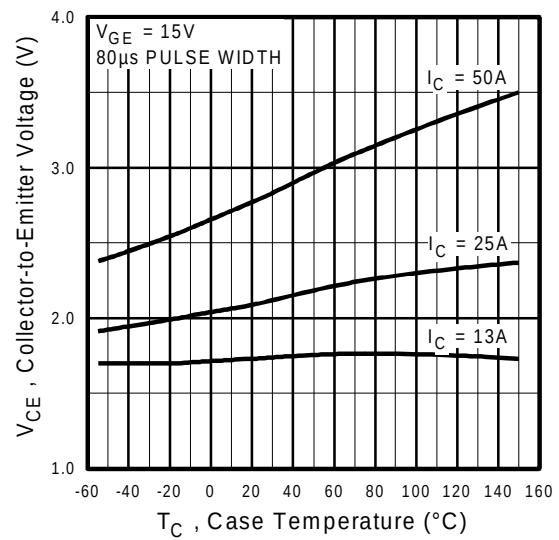
**Fig. 2 - Typical Output Characteristics**



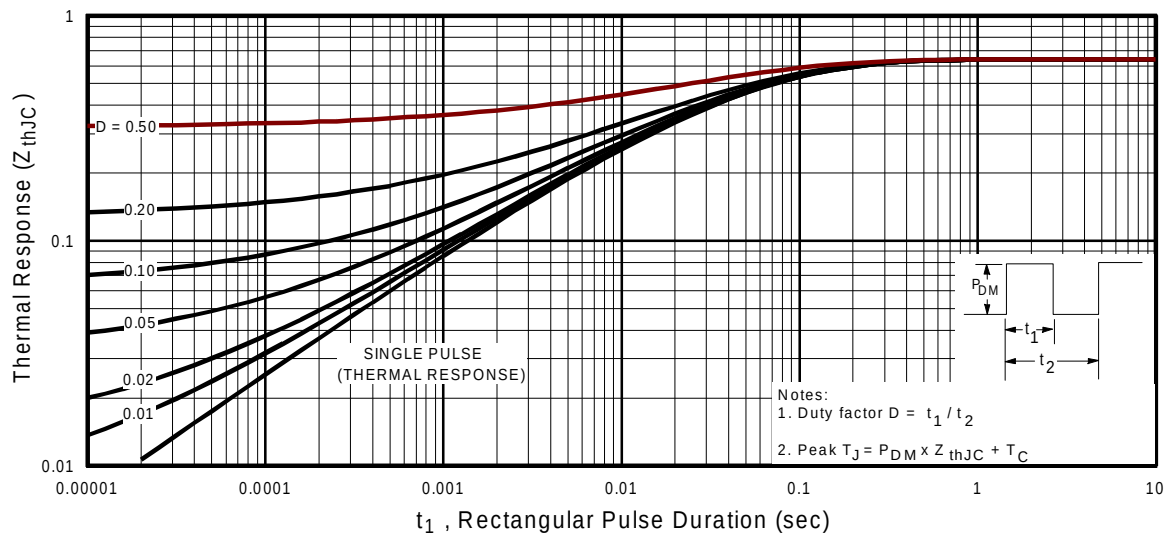
**Fig. 3 - Typical Transfer Characteristics**



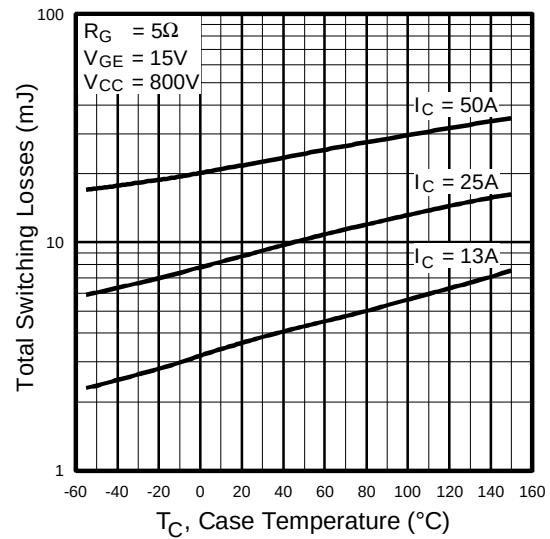
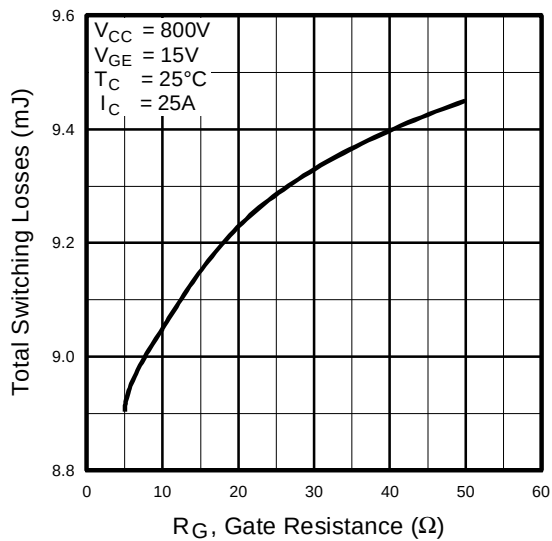
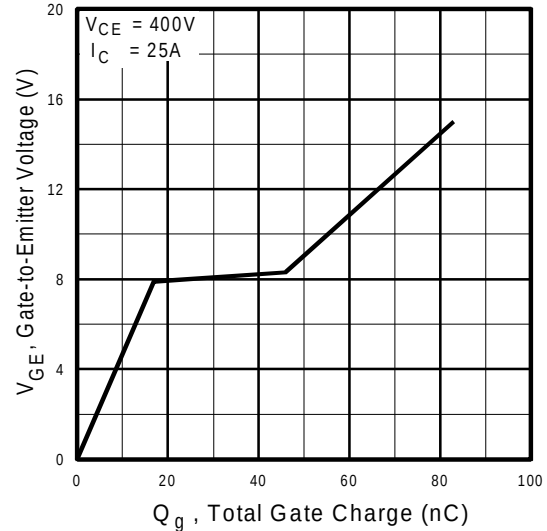
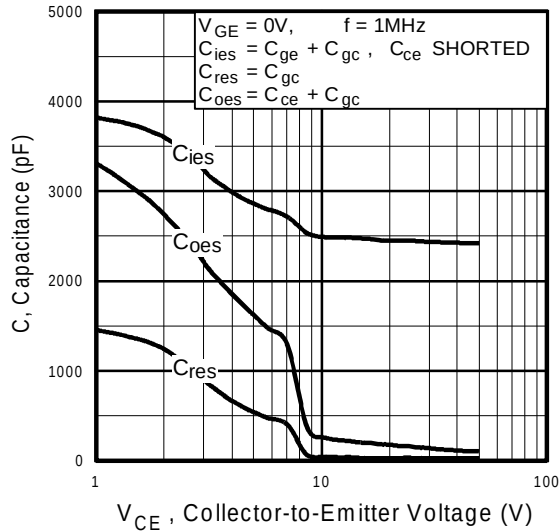
**Fig. 4 - Maximum Collector Current vs. Case Temperature**



**Fig. 5 - Collector-to-Emitter Voltage vs. Case Temperature**



**Fig. 6 - Maximum IGBT Effective Transient Thermal Impedance, Junction-to-Case**



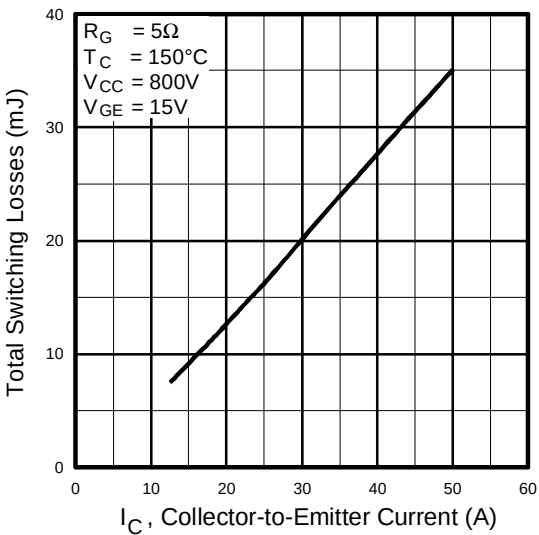


Fig. 11 - Typical Switching Losses vs. Collector-to-Emitter Current

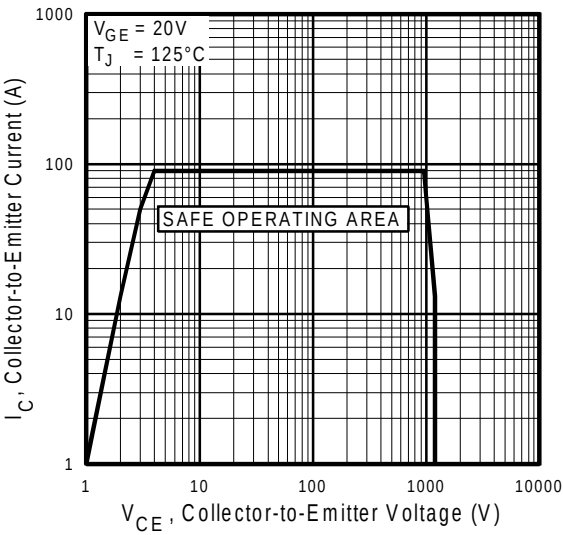


Fig. 12 - Turn-Off SOA

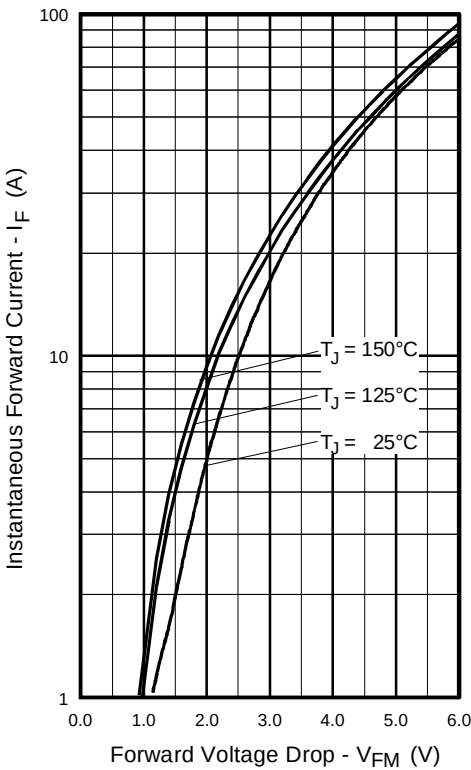
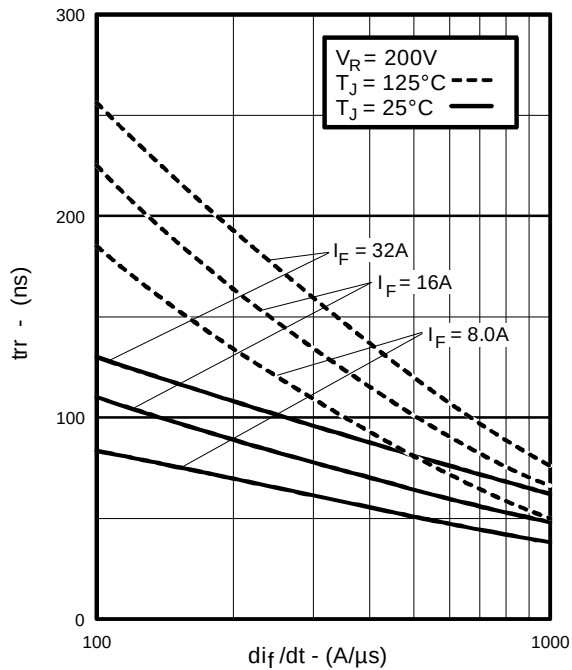
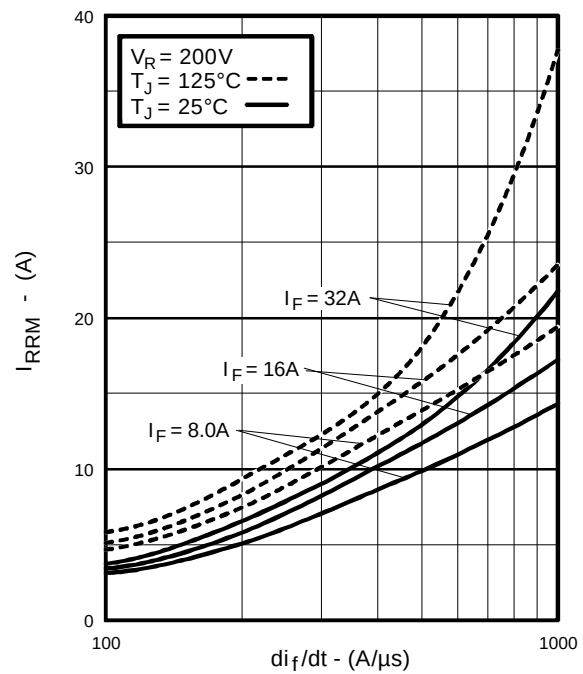


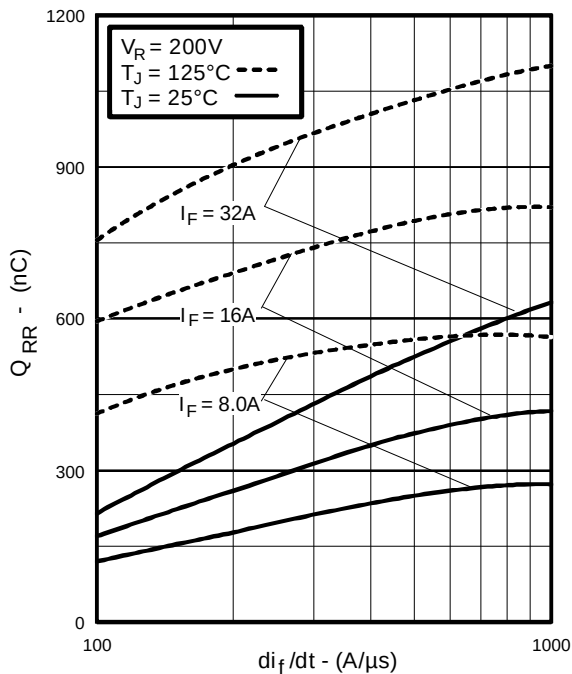
Fig. 13 - Maximum Forward Voltage Drop vs. Instantaneous Forward Current



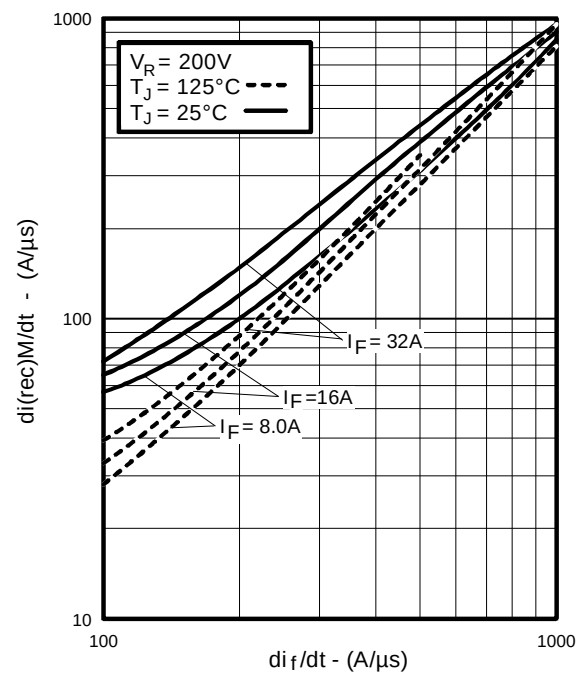
**Fig. 14** - Typical Reverse Recovery vs.  $di_f/dt$



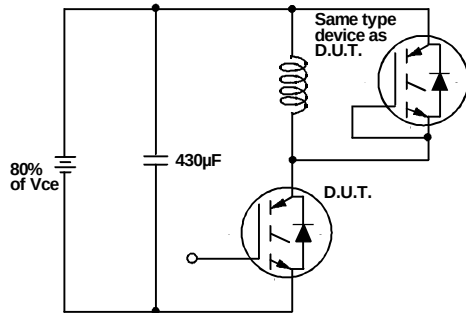
**Fig. 15** - Typical Recovery Current vs.  $di_f/dt$



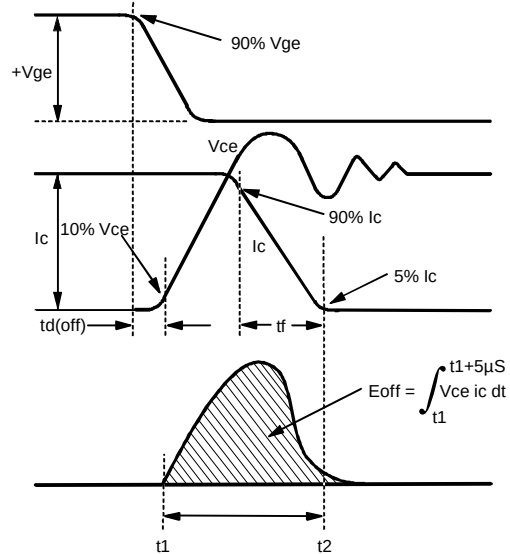
**Fig. 16** - Typical Stored Charge vs.  $di_f/dt$



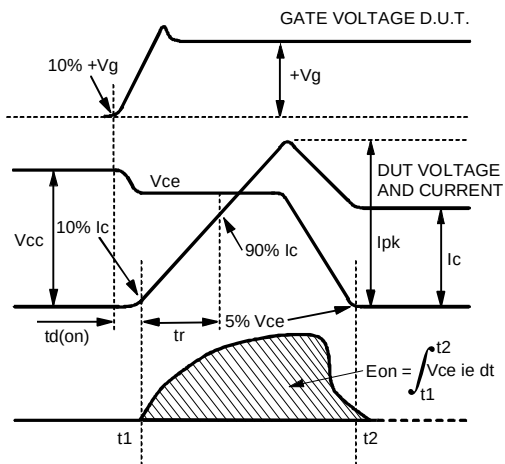
**Fig. 17** - Typical  $di_{(rec)}M/dt$  vs.  $di_f/dt$



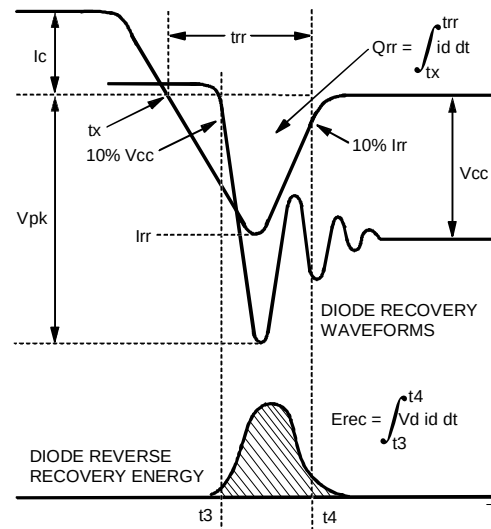
**Fig. 18a** - Test Circuit for Measurement of  $I_{LM}$ ,  $E_{on}$ ,  $E_{off(diode)}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$ ,  $t_{d(on)}$ ,  $t_r$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18b** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{off}$ ,  $t_{d(off)}$ ,  $t_f$



**Fig. 18c** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{on}$ ,  $t_{d(on)}$ ,  $t_r$



**Fig. 18d** - Test Waveforms for Circuit of Fig. 18a, Defining  $E_{rec}$ ,  $t_{rr}$ ,  $Q_{rr}$ ,  $I_{rr}$

**Refer to Section D for the following:**  
**Appendix H: Section D - page D-10**

Fig. 18e - Macro Waveforms for Test Circuit Fig. 18a

Fig. 19 - Clamped Inductive Load Test Circuit

Fig. 20 - Pulsed Collector Current Test Circuit